

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Inventor(s): Hisao KOGA et al.

Art Unit 2827

Appln. No.:

10/747,982

Exr. Ti. Cmiz

Filed:

December 31, 2003

For:

RESIN MOLDED TYPE SEMICONDUCTOR DEVICE AND A

METHOD OF MANUFACTURING THE SAME

PETITION TO MAKE SPECIAL

Assistant Commissioner of Patents Washington, DC 20231

Sir:

The Applicants respectfully petition that the above-captioned application be granted special status. This application is a continuing application of 09/380,312 filed August 31, 1999. The requirements of MPEP section 708.02(VIII) are complied with as follows:

- (1) Please charge the petition fee set forth in 37 CFR 1.17(2) to Deposit Account No. 19-4375.
- (2) All pending claims of the present application are believed to be directed to a single invention; if the Office determines that all the claims presented are not obviously directed to a single invention, the Applicants agree to make an election without traverse as a prerequisite to the grant of 4 special 36 status.

PAGE 13/27 * RCVD AT 5/19/2004 4:50:45 PM (Eastern Daylight-Time) * SVR:USPTO-EFXRF-1/3 * DNIS:8729306 * CSID:2024085200 * DURATION (mm-ss):06-00